

# ENGINEERING INNOVATION

Reimagining Engineering—One Future at a Time



JOHNS HOPKINS  
WHITING SCHOOL  
of ENGINEERING

## Official Transcript Request

Name of Student: \_\_\_\_\_

School Name: \_\_\_\_\_

is applying for a college course through Johns Hopkins University called **Explore Engineering Innovation (EEI)** or **Biomedical Engineering Innovation (BMEI)**. Please forward the following document(s):

- An official transcript
- A report card for the most recent grading period, if those grades are not included in the transcript

Signature of individual requesting transcript: \_\_\_\_\_

The student is applying to (check one)

- Explore Engineering Innovation (EEI)
- Biomedical Engineering Innovation (BMEI)

Date: \_\_\_\_\_

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Please email a copy of the document(s) to [ei-transcripts@jhu.edu](mailto:ei-transcripts@jhu.edu) and include this cover sheet.

I certify that the transcript emailed with this cover letter has been validated and is accurate.

School Representative validating transcript name (printed): \_\_\_\_\_

School Representative Title: \_\_\_\_\_

School Representative signature: \_\_\_\_\_

Date: \_\_\_\_\_

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For our office to consider the transcript "official," it must be emailed by a school official, not the student or parent/guardian. If you have questions or concerns, please contact us at [ei-transcripts@jhu.edu](mailto:ei-transcripts@jhu.edu).